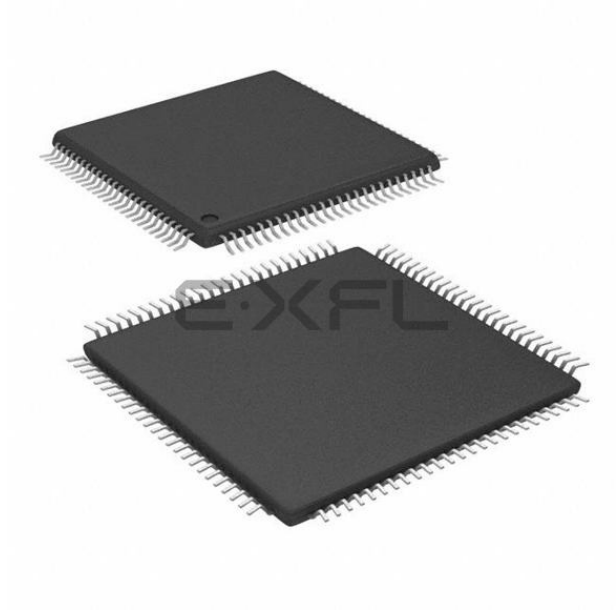
Microchip Technology - PIC32MZ0512EFK100-I/PT Datasheet



Welcome to E-XFL.COM

What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	MIPS32® M-Class
Core Size	32-Bit Single-Core
Speed	200MHz
Connectivity	CANbus, EBI/EMI, Ethernet, I²C, PMP, SPI, SQI, UART/USART, USB OTG
Peripherals	Brown-out Detect/Reset, DMA, I²S, POR, PWM, WDT
Number of I/O	78
Program Memory Size	512KB (512K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	128K x 8
Voltage - Supply (Vcc/Vdd)	2.1V ~ 3.6V
Data Converters	A/D 40x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	100-TQFP
Supplier Device Package	100-TQFP (12x12)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic32mz0512efk100-i-pt

TABLE 1-6: PORTA THROUGH PORTK PINOUT I/O DESCRIPTIONS

Pin Name	Pin Number				Pin Type	Buffer Type	Description
	64-pin QFN/ TQFP	100-pin TQFP	124-pin VTLA	144-pin TQFP/ LQFP			
PORTA							
RA0	—	17	A11	22	I/O	ST	PORTA is a bidirectional I/O port
RA1	—	38	B21	56	I/O	ST	
RA2	—	59	A41	85	I/O	ST	
RA3	—	60	B34	86	I/O	ST	
RA4	—	61	A42	87	I/O	ST	
RA5	—	2	B1	2	I/O	ST	
RA6	—	89	A61	129	I/O	ST	
RA7	—	90	B51	130	I/O	ST	
RA9	—	28	B15	39	I/O	ST	
RA10	—	29	A20	40	I/O	ST	
RA14	—	66	B37	95	I/O	ST	
RA15	—	67	A45	96	I/O	ST	
PORTB							
RB0	16	25	A18	36	I/O	ST	PORTB is a bidirectional I/O port
RB1	15	24	A17	35	I/O	ST	
RB2	14	23	A16	34	I/O	ST	
RB3	13	22	A14	31	I/O	ST	
RB4	12	21	A13	26	I/O	ST	
RB5	11	20	B11	25	I/O	ST	
RB6	17	26	B14	37	I/O	ST	
RB7	18	27	A19	38	I/O	ST	
RB8	21	32	B18	47	I/O	ST	
RB9	22	33	A23	48	I/O	ST	
RB10	23	34	B19	49	I/O	ST	
RB11	24	35	A24	50	I/O	ST	
RB12	27	41	A27	59	I/O	ST	
RB13	28	42	B23	60	I/O	ST	
RB14	29	43	A28	61	I/O	ST	
RB15	30	44	B24	62	I/O	ST	
PORTC							
RC1	—	6	B3	6	I/O	ST	PORTC is a bidirectional I/O port
RC2	—	7	A6	11	I/O	ST	
RC3	—	8	B5	12	I/O	ST	
RC4	—	9	A7	13	I/O	ST	
RC12	31	49	B28	71	I/O	ST	
RC13	47	72	B41	105	I/O	ST	
RC14	48	73	A49	106	I/O	ST	
RC15	32	50	A33	72	I/O	ST	

Legend: CMOS = CMOS-compatible input or output; ST = Schmitt Trigger input with CMOS levels; TTL = Transistor-transistor Logic input buffer; Analog = Analog input; O = Output; PPS = Peripheral Pin Select; P = Power; I = Input

TABLE 1-6: PORTA THROUGH PORTK PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number				Pin Type	Buffer Type	Description
	64-pin QFN/ TQFP	100-pin TQFP	124-pin VTLA	144-pin TQFP/ LQFP			
PORTK							
RK0	—	—	—	19	I/O	ST	PORTK is a bidirectional I/O port
RK1	—	—	—	51	I/O	ST	
RK2	—	—	—	52	I/O	ST	
RK3	—	—	—	53	I/O	ST	
RK4	—	—	—	92	I/O	ST	
RK5	—	—	—	93	I/O	ST	
RK6	—	—	—	94	I/O	ST	
RK7	—	—	—	126	I/O	ST	

Legend: CMOS = CMOS-compatible input or output; Analog = Analog input; P = Power
ST = Schmitt Trigger input with CMOS levels; O = Output; I = Input
TTL = Transistor-transistor Logic input buffer; PPS = Peripheral Pin Select

3.7 M-Class Core Configuration

Register 3-1 through Register 3-4 show the default configuration of the M-Class core, which is included on the PIC32MZ EF family of devices.

REGISTER 3-1: CONFIG: CONFIGURATION REGISTER; CP0 REGISTER 16, SELECT 0

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	r-1	U-0	U-0	U-0	U-0	U-0	U-0	R-0
	—	—	—	—	—	—	—	ISP
23:16	R-0	R-0	R-1	R-0	U-0	R-1	R-0	R-0
	DSP	UDI	SB	MDU	—	MM<1:0>		BM
15:8	R-0	R-0	R-0	R-0	R-0	R-1	R-0	R-0
	BE	AT<1:0>		AR<2:0>			MT<2:1>	
7:0	R-1	U-0	U-0	U-0	U-0	R/W-0	R/W-1	R/W-0
	MT<0>	—	—	—	—	K0<2:0>		

Legend:	r = Reserved bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31 **Reserved:** This bit is hardwired to '1' to indicate the presence of the Config1 register.

bit 30-25 **Unimplemented:** Read as '0'

bit 24 **ISP:** Instruction Scratch Pad RAM bit
0 = Instruction Scratch Pad RAM is not implemented

bit 23 **DSP:** Data Scratch Pad RAM bit
0 = Data Scratch Pad RAM is not implemented

bit 22 **UDI:** User-defined bit
0 = CorExtend User-Defined Instructions are not implemented

bit 21 **SB:** SimpleBE bit
1 = Only Simple Byte Enables are allowed on the internal bus interface

bit 20 **MDU:** Multiply/Divide Unit bit
0 = Fast, high-performance MDU

bit 19 **Unimplemented:** Read as '0'

bit 18-17 **MM<1:0>:** Merge Mode bits
10 = Merging is allowed

bit 16 **BM:** Burst Mode bit
0 = Burst order is sequential

bit 15 **BE:** Endian Mode bit
0 = Little-endian

bit 14-13 **AT<1:0>:** Architecture Type bits
00 = MIPS32

bit 12-10 **AR<2:0>:** Architecture Revision Level bits
001 = MIPS32 Release 2

bit 9-7 **MT<2:0>:** MMU Type bits
001 = M-Class MPU Microprocessor core uses a TLB-based MMU

bit 6-3 **Unimplemented:** Read as '0'

bit 2-0 **K0<2:0>:** Kseg0 Coherency Algorithm bits
011 = Cacheable, non-coherent, write-back, write allocate
010 = Uncached
001 = Cacheable, non-coherent, write-through, write allocate
000 = Cacheable, non-coherent, write-through, no write allocate
All other values are not used and mapped to other values. 100, 101, and 110 are mapped to 010. 111 is mapped to 010.

TABLE 4-17: SYSTEM BUS TARGET 9 REGISTER MAP

Virtual Address (BF8F_#)	Register Name	Bit Range	Bits																All Resets
			31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4	19/3	18/2	17/1	16/0	
A420	SBT9ELOG1	31:16	MULTI	—	—	—	CODE<3:0>				—	—	—	—	—	—	—	—	0000
		15:0	INITID<7:0>								REGION<3:0>				—	CMD<2:0>			0000
A424	SBT9ELOG2	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	—	—	—	—	—	—	—	—	—	—	—	—	—	—	GROUP<1:0>		0000
A428	SBT9ECON	31:16	—	—	—	—	—	—	—	ERRP	—	—	—	—	—	—	—	—	0000
		15:0	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
A430	SBT9ECLRS	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	CLEAR	0000
A438	SBT9ECLRM	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	CLEAR	0000
A440	SBT9REG0	31:16	BASE<21:6>																xxxx
		15:0	BASE<5:0>						PRI	—	SIZE<4:0>					—	—	—	xxxx
A450	SBT9RD0	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	xxxx
		15:0	—	—	—	—	—	—	—	—	—	—	—	—	GROUP3	GROUP2	GROUP1	GROUP0	xxxx
A458	SBT9WR0	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	xxxx
		15:0	—	—	—	—	—	—	—	—	—	—	—	—	GROUP3	GROUP2	GROUP1	GROUP0	xxxx
A460	SBT9REG1	31:16	BASE<21:6>																xxxx
		15:0	BASE<5:0>						PRI	—	SIZE<4:0>					—	—	—	xxxx
A470	SBT9RD1	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	xxxx
		15:0	—	—	—	—	—	—	—	—	—	—	—	—	GROUP3	GROUP2	GROUP1	GROUP0	xxxx
A478	SBT9WR1	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	xxxx
		15:0	—	—	—	—	—	—	—	—	—	—	—	—	GROUP3	GROUP2	GROUP1	GROUP0	xxxx

Legend: x = unknown value on Reset; — = unimplemented, read as '0'. Reset values are shown in hexadecimal.
Note: For reset values listed as 'xxxx', please refer to Table 4-6 for the actual reset values.

REGISTER 11-11: USBIENCSR3: USB INDEXED ENDPOINT CONTROL STATUS REGISTER 3 (ENDPOINT 1-7)

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	R-x	R-x	R-x	R-x	R-x	R-x	R-x	R-x
	RXFIFOSZ<3:0>				TXFIFOSZ<3:0>			
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
15:8	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	RXINTERV<7:0>							
7:0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	SPEED<1:0>		PROTOCOL<1:0>		TEP<3:0>			

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-28 **RXFIFOSZ<3:0>:** Receive FIFO Size bits
1111 = Reserved
1110 = Reserved
1101 = 8192 bytes
1100 = 4096 bytes
•
•
•
0011 = 8 bytes
0010 = Reserved
0001 = Reserved
0000 = Reserved or endpoint has not been configured

This register only has this interpretation when dynamic sizing is not selected. It is not valid where dynamic FIFO sizing is used.

bit 27-24 **TXFIFOSZ<3:0>:** Transmit FIFO Size bits
1111 = Reserved
1110 = Reserved
1101 = 8192 bytes
1100 = 4096 bytes
•
•
•
0011 = 8 bytes
0010 = Reserved
0001 = Reserved
0000 = Reserved or endpoint has not been configured

This register only has this interpretation when dynamic sizing is not selected. It is not valid where dynamic FIFO sizing is used.

bit 23-16 **Unimplemented:** Read as '0'

REGISTER 11-22: USBDMAxA: USB DMA CHANNEL 'x' MEMORY ADDRESS REGISTER ('x' = 1-8)

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	DMAADDR<31:24>							
23:16	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	DMAADDR<23:16>							
15:8	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	DMAADDR<15:8>							
7:0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R-0	R-0
	DMAADDR<7:0>							

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-0 **DMAADDR<31:0>:** DMA Memory Address bits

This register identifies the current memory address of the corresponding DMA channel. The initial memory address written to this register during initialization must have a value such that its modulo 4 value is equal to '0'. The lower two bits of this register are read only and cannot be set by software. As the DMA transfer progresses, the memory address will increment as bytes are transferred.

REGISTER 11-23: USBDMAxN: USB DMA CHANNEL 'x' COUNT REGISTER ('X' = 1-8)

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	DMACOUNT<31:24>							
23:16	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	DMACOUNT<23:16>							
15:8	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	DMACOUNT<15:8>							
7:0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	DMACOUNT<7:0>							

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-0 **DMACOUNT<31:0>:** DMA Transfer Count bits

This register identifies the current DMA count of the transfer. Software will set the initial count of the transfer which identifies the entire transfer length. As the count progresses this count is decremented as bytes are transferred.

REGISTER 15-1: DMTCON: DEADMAN TIMER CONTROL REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
15:8	R/W-y	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	ON(1)	—	—	—	—	—	—	—
7:0	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—

Legend:		y = Value set from Configuration bits on POR	
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-16 **Unimplemented:** Read as '0'

bit 15 **ON:** Deadman Timer Module Enable bit(1)
1 = Deadman Timer module is enabled
0 = Deadman Timer module is disabled
The reset value of this bit is determined by the setting of the FDMTEN bit (DEVCFG1<3>).

bit 13-0 **Unimplemented:** Read as '0'

Note 1: This bit only has control when FDMTEN (DEVCFG1<3>) = 0.

REGISTER 15-2: DMTPRECLR: DEADMAN TIMER PRECLEAR REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
15:8	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	STEP1<7:0>							
7:0	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-16 **Unimplemented:** Read as '0'

bit 15-8 **STEP1<7:0>:** Preclear Enable bits
01000000 = Enables the Deadman Timer Preclear (Step 1)
All other write patterns = Set BAD1 flag.
These bits are cleared when a DMT reset event occurs. STEP1<7:0> is also cleared if the STEP2<7:0> bits are loaded with the correct value in the correct sequence.

bit 7-0 **Unimplemented:** Read as '0'

REGISTER 15-4: DMTSTAT: DEADMAN TIMER STATUS REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
15:8	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
7:0	R-0, HC, HS	R-0, HC, HS	R-0, HC, HS	U-0	U-0	U-0	U-0	R-0, HC, HS
	BAD1	BAD2	DMTEVENT	—	—	—	—	WINOPN

Legend:	HC = Hardware Cleared	HS = Hardware Set	
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-8 **Unimplemented:** Read as '0'

bit 7 **BAD1:** Bad STEP1<7:0> Value Detect bit
- 1 = Incorrect STEP1<7:0> value was detected
- 0 = Incorrect STEP1<7:0> value was not detected

bit 6 **BAD2:** Bad STEP2<7:0> Value Detect bit
- 1 = Incorrect STEP2<7:0> value was detected
- 0 = Incorrect STEP2<7:0> value was not detected

bit 5 **DMTEVENT:** Deadman Timer Event bit
- 1 = Deadman timer event was detected (counter expired or bad STEP1<7:0> or STEP2<7:0> value was entered prior to counter increment)
- 0 = Deadman timer even was not detected

bit 4-1 **Unimplemented:** Read as '0'

bit 0 **WINOPN:** Deadman Timer Clear Window bit
- 1 = Deadman timer clear window is open
- 0 = Deadman timer clear window is not open

NOTES:

REGISTER 23-1: PMCON: PARALLEL PORT CONTROL REGISTER (CONTINUED)

bit 7-6 **CSF<1:0>:** Chip Select Function bits(1)
- 11 = Reserved
- 10 = PMCS1 and PMCS2 function as Chip Select
- 01 = PMCS2 functions as Chip Select and PMCS1 functions as address bit 14
- 00 = PMCS1 and PMCS2 function as address bit 14 and address bit 15

bit 5 **ALP:** Address Latch Polarity bit(1)
- 1 = Active-high (PMALL and PMALH)
- 0 = Active-low ($\overline{\text{PMALL}}$ and $\overline{\text{PMALH}}$)

bit 4 **CS2P:** Chip Select 2 Polarity bit(1)
- 1 = Active-high (PMCS2)
- 0 = Active-low ($\overline{\text{PMCS2}}$)

bit 3 **CS1P:** Chip Select 1 Polarity bit(1)
- 1 = Active-high (PMCS1)
- 0 = Active-low ($\overline{\text{PMCS1}}$)

bit 2 **Unimplemented:** Read as '0'

bit 1 **WRSP:** Write Strobe Polarity bit

For Slave Modes and Master mode 2 (MODE<1:0> = 00,01,10):
- 1 = Write strobe active-high (PMWR)
- 0 = Write strobe active-low ($\overline{\text{PMWR}}$)

For Master mode 1 (MODE<1:0> = 11):
- 1 = Enable strobe active-high (PMENB)
- 0 = Enable strobe active-low ($\overline{\text{PMENB}}$)

bit 0 **RDSP:** Read Strobe Polarity bit

For Slave modes and Master mode 2 (MODE<1:0> = 00,01,10):
- 1 = Read Strobe active-high (PMRD)
- 0 = Read Strobe active-low ($\overline{\text{PMRD}}$)

For Master mode 1 (MODE<1:0> = 11):
- 1 = Read/write strobe active-high (PMRD/$\overline{\text{PMWR}}$)
- 0 = Read/write strobe active-low ($\overline{\text{PMRD}}$/PMWR)

Note 1: These bits have no effect when their corresponding pins are used as address lines.

REGISTER 28-1: ADCCON1: ADC CONTROL REGISTER 1 (CONTINUED)

bit 3 **STRGLVL:** Scan Trigger High Level/Positive Edge Sensitivity bit
1 = Scan trigger is high level sensitive. Once STRIG mode is selected (TRGSRCx<4:0> in the ADCTRGx register), the scan trigger will continue for all selected analog inputs, until the STRIG option is removed.
0 = Scan trigger is positive edge sensitive. Once STRIG mode is selected (TRGSRCx<4:0> in the ADCTRGx register), only a single scan trigger will be generated, which will complete the scan of all selected analog inputs.

bit 2-0 **Unimplemented:** Read as '0'

REGISTER 28-20: ADCCMPCON1: ADC DIGITAL COMPARATOR 1 CONTROL REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	R-0, HS, HC	R-0, HS, HC	R-0, HS, HC	R-0, HS, HC	R-0, HS, HC	R-0, HS, HC	R-0, HS, HC	R-0, HS, HC
	CVDDATA<15:8>							
23:16	R-0, HS, HC	R-0, HS, HC	R-0, HS, HC	R-0, HS, HC	R-0, HS, HC	R-0, HS, HC	R-0, HS, HC	R-0, HS, HC
	CVDDATA<7:0>							
15:8	U-0	U-0	R-0, HS, HC	R-0, HS, HC	R-0, HS, HC	R-0, HS, HC	R-0, HS, HC	R-0, HS, HC
	—	—	AINID<5:0>					
7:0	R/W-0	R/W-0	R-0, HS, HC	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	ENDCMP	DCMPGIEN	DCMPED	IEBTWN	IEHIHI	IEHILO	IELOHI	IELOLO

Legend:	HS = Hardware Set	HC = Hardware Cleared	
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-16 **CVDDATA<15:0>:** CVD Data Status bits

In CVD mode, these bits obtain the CVD differential output data (subtraction of CVD positive and negative measurement), whenever a Digital Comparator interrupt is generated. The value in these bits is compliant with the FRACT bit (ADCCON1<23>) and is always signed.

bit 15-14 **Unimplemented:** Read as '0'

bit 13-8 **AINID<5:0>:** Digital Comparator 0 Analog Input Identification (ID) bits

When a digital comparator event occurs (DCMPED = 1), these bits identify the analog input being monitored by Digital Comparator 0.

Note: In normal ADC mode, only analog inputs <31:0> can be processed by the Digital Comparator 0. The Digital Comparator 0 also supports the CVD mode, in which all Class 2 and Class 3 analog inputs may be stored in the AINID<5:0> bits.

111111 = Reserved
•
•
•
101101 = Reserved
101100 = AN44 is being monitored
101011 = AN43 is being monitored
•
•
•
000001 = AN1 is being monitored
000000 = AN0 is being monitored

bit 7 **ENDCMP:** Digital Comparator 0 Enable bit

1 = Digital Comparator 0 is enabled

0 = Digital Comparator 0 is not enabled, and the DCMPED status bit (ADCCMP0CON<5>) is cleared

bit 6 **DCMPGIEN:** Digital Comparator 0 Global Interrupt Enable bit

1 = A Digital Comparator 0 interrupt is generated when the DCMPED status bit (ADCCMP0CON<5>) is set

0 = A Digital Comparator 0 interrupt is disabled

bit 5 **DCMPED:** Digital Comparator 0 "Output True" Event Status bit

The logical conditions under which the digital comparator gets "True" are defined by the IEBTWN, IEHIHI, IEHILO, IELOHI, and IELOLO bits.

Note: This bit is cleared by reading the AINID<5:0> bits or by disabling the Digital Comparator module (by setting ENDCMP to '0').

1 = Digital Comparator 0 output true event has occurred (output of Comparator is '1')

0 = Digital Comparator 0 output is false (output of comparator is '0')

bit 4 **IEBTWN:** Between Low/High Digital Comparator 0 Event bit

1 = Generate a digital comparator event when DCMPLO<15:0> ≤ DATA<31:0> < DCMPHI<15:0>

0 = Do not generate a digital comparator event

REGISTER 28-27: ADCxTIME: DEDICATED ADCx TIMING REGISTER 'x' ('x' = 0 THROUGH 4)

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-1	R/W-1
	—	—	—	ADCEIS<2:0>			SELRES<1:0>	
23:16	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	—	ADCDIV<6:0>						
15:8	U-0	U-0	U-0	U-0	U-0	U-0	R/W-0	R/W-0
	—	—	—	—	—	—	SAMC<9:8>	
7:0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	SAMC<7:0>							

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-29 **Unimplemented:** Read as '0'

bit 28-26 **ADCEIS<2:0>:** ADCx Early Interrupt Select bits

111 = The data ready interrupt is generated 8 ADC clocks prior to the end of conversion
110 = The data ready interrupt is generated 7 ADC clocks prior to the end of conversion
•
•
•
001 = The data ready interrupt is generated 2 ADC clocks prior to the end of conversion
000 = The data ready interrupt is generated 1 ADC clock prior to the end of conversion

Note: All options are available when the selected resolution, specified by the SELRES<1:0> bits (ADCxTIME<25:24>), is 12-bit or 10-bit. For a selected resolution of 8-bit, options from '000' to '101' are valid. For a selected resolution of 6-bit, options from '000' to '011' are valid.

bit 25-24 **SELRES<1:0>:** ADCx Resolution Select bits

11 = 12 bits
10 = 10 bits
01 = 8 bits
00 = 6 bits

Note: Changing the resolution of the ADC does not shift the result in the corresponding ADCDATAx register. The result will still occupy 12 bits, with the corresponding lower unused bits set to '0'. For example, a resolution of 6 bits will result in ADCDATAx<5:0> being set to '0', and ADCDATAx<11:6> holding the result.

bit 23 **Unimplemented:** Read as '0'

bit 22-16 **ADCDIV<6:0>:** ADCx Clock Divisor bits

These bits divide the ADC control clock with period TQ to generate the clock for ADCx (TADx).

1111111 = 254 * TQ = TADx
•
•
•
0000011 = 6 * TQ = TADx
0000010 = 4 * TQ = TADx
0000001 = 2 * TQ = TADx
0000000 = Reserved

bit 15-10 **Unimplemented:** Read as '0'

bit 9-0 **SAMC<9:0>:** ADCx Sample Time bits

Where TADx = period of the ADC conversion clock for the dedicated ADC controlled by the ADCDIV<6:0> bits.

1111111111 = 1025 TADx
•
•
•
0000000001 = 3 TADx
0000000000 = 2 TADx

REGISTER 29-10: CiFLTCON0: CAN FILTER CONTROL REGISTER 0

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	FLTEN3	MSEL3<1:0>		FSEL3<4:0>				
23:16	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	FLTEN2	MSEL2<1:0>		FSEL2<4:0>				
15:8	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	FLTEN1	MSEL1<1:0>		FSEL1<4:0>				
7:0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	FLTEN0	MSEL0<1:0>		FSEL0<4:0>				

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31 **FLTEN3:** Filter 3 Enable bit
1 = Filter is enabled
0 = Filter is disabled

bit 30-29 **MSEL3<1:0>:** Filter 3 Mask Select bits
11 = Acceptance Mask 3 selected
10 = Acceptance Mask 2 selected
01 = Acceptance Mask 1 selected
00 = Acceptance Mask 0 selected

bit 28-24 **FSEL3<4:0>:** FIFO Selection bits
11111 = Message matching filter is stored in FIFO buffer 31
11110 = Message matching filter is stored in FIFO buffer 30
•
•
•
00001 = Message matching filter is stored in FIFO buffer 1
00000 = Message matching filter is stored in FIFO buffer 0

bit 23 **FLTEN2:** Filter 2 Enable bit
1 = Filter is enabled
0 = Filter is disabled

bit 22-21 **MSEL2<1:0>:** Filter 2 Mask Select bits
11 = Acceptance Mask 3 selected
10 = Acceptance Mask 2 selected
01 = Acceptance Mask 1 selected
00 = Acceptance Mask 0 selected

bit 20-16 **FSEL2<4:0>:** FIFO Selection bits
11111 = Message matching filter is stored in FIFO buffer 31
11110 = Message matching filter is stored in FIFO buffer 30
•
•
•
00001 = Message matching filter is stored in FIFO buffer 1
00000 = Message matching filter is stored in FIFO buffer 0

Note: The bits in this register can only be modified if the corresponding filter enable (FLTENn) bit is '0'.

REGISTER 30-3: ETHTXST: ETHERNET CONTROLLER TX PACKET DESCRIPTOR START ADDRESS REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	TXSTADDR<31:24>							
23:16	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	TXSTADDR<23:16>							
15:8	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	TXSTADDR<15:8>							
7:0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	U-0	U-0
	TXSTADDR<7:2>						—	—

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-2 **TXSTADDR<31:2>:** Starting Address of First Transmit Descriptor bits
This register should not be written while any transmit, receive or DMA operations are in progress.
This address must be 4-byte aligned (bits 1-0 must be '00').

bit 1-0 **Unimplemented:** Read as '0'

Note 1: This register is only used for TX operations.
2: This register will be updated by hardware with the last descriptor used by the last successfully transmitted packet.

REGISTER 30-4: ETHRXST: ETHERNET CONTROLLER RX PACKET DESCRIPTOR START ADDRESS REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	RXSTADDR<31:24>							
23:16	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	RXSTADDR<23:16>							
15:8	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	RXSTADDR<15:8>							
7:0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	U-0	U-0
	RXSTADDR<7:2>						—	—

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-2 **RXSTADDR<31:2>:** Starting Address of First Receive Descriptor bits
This register should not be written while any transmit, receive or DMA operations are in progress.
This address must be 4-byte aligned (bits 1-0 must be '00').

bit 1-0 **Unimplemented:** Read as '0'

Note 1: This register is only used for RX operations.
2: This register will be updated by hardware with the last descriptor used by the last successfully transmitted packet.

TABLE 37-14: COMPARATOR SPECIFICATIONS

DC CHARACTERISTICS			Standard Operating Conditions (see Note 3): 2.1V to 3.6V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended				
Param. No.	**Symbol**	**Characteristics**	**Min.**	**Typical**	**Max.**	**Units**	**Comments**
D300	VIOFF	Input Offset Voltage	—	±10	—	mV	AVDD = VDD, AVSS = VSS
D301	VICM	Input Common Mode Voltage	0	—	VDD	V	AVDD = VDD, AVSS = VSS **(Note 2)**
D302	CMRR	Common Mode Rejection Ratio	55	—	—	dB	Max VICM = (VDD – 1)V **(Note 2, 4)**
D303	TRESP	Response Time	—	150	—	ns	AVDD = VDD, AVSS = VSS **(Notes 1, 2)**
D304	ON2OV	Comparator Enabled to Output Valid	—	—	10	µs	Comparator module is configured before setting the comparator ON bit **(Note 2)**
D305	IVREF	Internal Voltage Reference	1.194	1.2	1.206	V	—

Note 1: Response time measured with one comparator input at (VDD – 1.5)/2, while the other input transitions from VSS to VDD.

2: These parameters are characterized but not tested.

3: The Comparator module is functional at VBORMIN < VDD < VDDMIN, but with degraded performance. Unless otherwise stated, module functionality is guaranteed, but not characterized.

4: CMRR measurement characterized with a 1 MΩ resistor in parallel with a 25 pF capacitor to VSS.

TABLE 37-15: COMPARATOR VOLTAGE REFERENCE SPECIFICATIONS

DC CHARACTERISTICS			Standard Operating Conditions (see Note 3): 2.1V to 3.6V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended				
Param. No.	**Symbol**	**Characteristics**	**Min.**	**Typ.**	**Max.**	**Units**	**Comments**
D312	TSET	Internal 4-bit DAC Comparator Reference Settling time	—	—	10	µs	See **Note 1**
D313	DACREFH	CVREF Input Voltage Reference Range	AVSS	—	AVDD	V	CVRSRC with CVRSS = 0
			VREF-	—	VREF+	V	CVRSRC with CVRSS = 1
D314	DVREF	CVREF Programmable Output Range	0	—	0.625 x DACREFH	V	0 to 0.625 DACREFH with DACREFH/24 step size
			0.25 x DACREFH	—	0.719 x DACREFH	V	0.25 x DACREFH to 0.719 DACREFH with DACREFH/32 step size
D315	DACRES	Resolution	—	—	DACREFH/24		CVRCON<CVRR> = 1
			—	—	DACREFH/32		CVRCON<CVRR> = 0
D316	DACACC	Absolute Accuracy(2)	—	—	1/4	LSB	DACREFH/24, CVRCON<CVRR> = 1
			—	—	1/2	LSB	DACREFH/32, CVRCON<CVRR> = 0

Note 1: Settling time was measured while CVRR = 1 and CVR<3:0> transitions from '0000' to '1111'. This parameter is characterized, but is not tested in manufacturing.

2: These parameters are characterized but not tested.

TABLE 37-23: I/O TIMING REQUIREMENTS

AC CHARACTERISTICS			Standard Operating Conditions: 2.1V to 3.6V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended				
Param. No.	**Symbol**	**Characteristics(2)**	**Min.**	**Typ.(1)**	**Max.**	**Units**	**Conditions**
DO31	TIOR	**Port Output Rise Time** I/O Pins: 4x Source Driver Pins - RA3, RA9, RA10, RA14, RA15 RB0-RB2, RB4, RB6-RB7, RB11, RB13 RC12-RC15 RD0, RD6-RD7, RD11, RD14 RE8, RE9 RF2, RF3, RF8 RG15 RH0, RH1, RH4-RH6, RH8-RH13 RJ0-RJ2, RJ8, RJ9, RJ11	—	—	9.5	ns	CLOAD = 50 pF
			—	—	6	ns	CLOAD = 20 pF
		Port Output Rise Time I/O Pins: 8x Source Driver Pins - RA0-RA2, RA4, RA5 RB3, RB5, RB8-RB10, RB12, RB14, RB15 RC1-RC4 RD1-RD5, RD9, RD10, RD12, RD13, RD15 RE4-RE7 RF0, RF4, RF5, RF12, RF13 RG0, RG1, RG6-RG9 RH2, RH3, RH7, RH14, RH15 RJ3-RJ7, RJ10, RJ12-RJ15 RK0-RK7	—	—	8	ns	CLOAD = 50 pF
			—	—	6	ns	CLOAD = 20 pF
		Port Output Rise Time I/O Pins: 12x Source Driver Pins - RA6, RA7 RE0-RE3 RF1 RG12-RG14	—	—	3.5	ns	CLOAD = 50 pF
			—	—	2	ns	CLOAD = 20 pF

Note 1: Data in "Typical" column is at 3.3V, +25°C unless otherwise stated.

2: This parameter is characterized, but not tested in manufacturing.

TABLE 37-33: SPIx MODULE SLAVE MODE (CKE = 1) TIMING REQUIREMENTS (CONTINUED)

AC CHARACTERISTICS			Standard Operating Conditions: 2.1V to 3.6V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended				
Param. No.	**Symbol**	**Characteristics(1)**	**Min.**	**Typical(2)**	**Max.**	**Units**	**Conditions**
SP50	TssL2scH, TssL2scL	$\overline{SSx}$ ↓ to SCKx ↓ or SCKx ↑ Input	88	—	—	ns	—
SP51	TssH2doZ	$\overline{SSx}$ ↑ to SDOx Output High-Impedance **(Note 4)**	2.5	—	12	ns	—
SP52	TscH2ssH TscL2ssH	$\overline{SSx}$ ↑ after SCKx Edge	10	—	—	ns	—
SP60	TssL2doV	SDOx Data Output Valid after $\overline{SSx}$ Edge	—	—	12.5	ns	—

Note 1: These parameters are characterized, but not tested in manufacturing.

2: Data in "Typical" column is at 3.3V, +25°C unless otherwise stated. Parameters are for design guidance only and are not tested.

3: The minimum clock period for SCKx is 20 ns.

4: Assumes 30 pF load on all SPIx pins.

TABLE 39-3: DC CHARACTERISTICS: IDLE CURRENT (I_{IDLE})

DC CHARACTERISTICS			Standard Operating Conditions: 2.1V to 3.6V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial	
Parameter No.	**Typical(2)**	**Maximum(4)**	**Units**	**Conditions**
Idle Current (I_{IDLE}): Core Off, Clock on Base Current (Note 1)				
MDC35	41	60	mA	252 MHz

Note 1: The test conditions for IIDLE current measurements are as follows:

- Oscillator mode is EC+PLL with OSC1 driven by external square wave from rail-to-rail, (OSC1 input clock input over/undershoot < 100 mV required)
- OSC2/CLKO is configured as an I/O input pin
- USB PLL is disabled (USBPMD = 1), VUSB3V3 is connected to VSS, PBCLKx divisor = 1:128 ('x' ≠ 7)
- CPU is in Idle mode (CPU core Halted)
- L1 Cache and Prefetch modules are disabled
- No peripheral modules are operating, (ON bit = 0), but the associated PMD bit is cleared (except USBPMD)
- WDT, DMT, Clock Switching, Fail-Safe Clock Monitor, and Secondary Oscillator are disabled
- All I/O pins are configured as inputs and pulled to VSS
- $\overline{MCLR}$ = VDD
- RTCC and JTAG are disabled

2: Data in "Typical" column is at 3.3V, +25°C unless otherwise stated. Parameters are for design guidance only and are not tested.

3: This parameter is characterized, but not tested in manufacturing.

4: Data in the "Maximum" column is at 3.3V, +85ºC at specified operating frequency, unless otherwise stated. Parameters are for design guidance only and are not tested.

A.8 Flash Programming

The PIC32MZ EF family of devices incorporates a new Flash memory technology. Applications ported from PIC32MX5XX/6XX/7XX devices that take advantage of Run-time Self Programming will need to adjust the Flash programming steps to incorporate these changes.

Table A-9 lists the differences (indicated by **Bold** type) that will affect software migration.

TABLE A-9: FLASH PROGRAMMING DIFFERENCES

PIC32MX5XX/6XX/7XX Feature	PIC32MZ EF Feature
Program Flash Write Protection	
On PIC32MX devices, the Program Flash write-protect bits are part of the Flash Configuration words (DEVCFG0). PWP<**7**:0> (**DEVCFG0<19:12>**) 11111111 = Disabled 11111110 = 0xBD000FFF 11111101 = 0xBD001FFF 11111100 = 0xBD002FFF 11111011 = 0xBD003FFF 11111010 = 0xBD004FFF 11111001 = 0xBD005FFF 11111000 = 0xBD006FFF 11110111 = 0xBD007FFF 11110110 = 0xBD008FFF 11110101 = 0xBD009FFF 11110100 = 0xBD00AFFF 11110011 = 0xBD00BFFF 11110010 = 0xBD00CFFF 11110001 = 0xBD00DFFF 11110000 = 0xBD00EFFF 11101111 = 0xBD00FFFF • • • 01111111 = 0xBD07FFFF	On PIC32MZ EF devices, the write-protect register is contained separately as the NVMPWP register. It has been expanded to 24 bits, and now represents the address below, which all Flash memory is protected. Note that the lower 14 bits are forced to zero, so that all memory locations in the page are protected. PWP<**23**:0> (**NVMPWP<23:0>**) Physical memory below address 0x1Dxxxxxx is write protected, where 'xxxxxx' is specified by PWP<23:0>. When PWP<23:0> has a value of '0', write protection is disabled for the entire program Flash. If the specified address falls within the page, the entire page and all pages below the current page will be protected.
Code Protection	
On PIC32MX devices, code protection is enabled by the CP (**DEVCFG**<28>) bit.	On PIC32MZ EF devices, code protection is enabled by the CP (**DEVCP0**<28>) bit.
Boot Flash Write Protection	
On PIC32MX devices, Boot Flash write protection is enable by the **BWP (DEVCFG<24>)** bit and protects the entire Boot Flash memory.	On PIC32MZ EF devices, Boot Flash write protection is divided into pages and is enable by the **LBWPx** and **UBWPx** bits in the **NVMBWP** register.
Low-Voltage Detect Status	
LVDSTAT (NVMCON<11>) 1 = Low-voltage event is active 0 = Low-voltage event is not active	The LVDSTAT bit is not available in PIC32MZ EF devices.